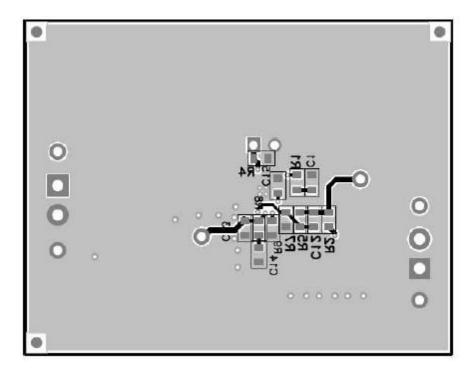


PMP10002\_RevB: Top Side Assembly



PMP10002\_RevB: Bottom Side Assembly

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